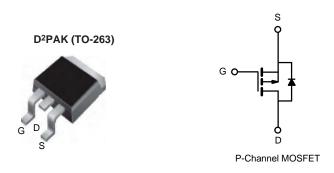


J276-VB Datasheet P-Channel 100 V (D-S) MOSFET

| PRODUCT SUMMARY | | | | |
|---------------------|-----------------------------------|--------------------|-----------------------|--|
| V _{DS} (V) | R _{DS(on)} (Ω) Max. | I _D (A) | Q _g (Typ.) | |
| -100 | 0.22 at V_{GS} = - 10 V | - 12 | 67 | |
| | 0.24 at V _{GS} = - 4.5 V | - 10 | 07 | |



FEATURES

- Halogen-free According to IEC 61249-2-21
 Definition
- Trench Power MOSFET
- 100 % R_g and UIS Tested
- Compliant to RoHS Directive 2002/95/EC

APPLICATIONS

- Power Switch
- Load Switch in High Current Applications
- DC/DC Converters

| ABSOLUTE MAXIMUM RATINGS | (T _C = 25 °C, unless oth | erwise noted) | | | |
|--|-------------------------------------|--------------------|----------------------|----|--|
| Parameter | Symbol | Limit | Unit | | |
| Drain-Source Voltage | V _{DS} | - 100 | V | | |
| Gate-Source Voltage | | V _{GS} | ± 20 | v | |
| Continuous Drain Current (T _J = 150 °C) | T _C = 25 °C | I _D | - 12 | | |
| Continuous Drain Current (1j = 150°C) | T _C = 70 °C | 0' | - 10 | A | |
| Pulsed Drain Current (t = 300 µs) | | I _{DM} | -40 | | |
| Avalanche Current | | I _{AS} | I _{AS} - 32 | | |
| Single Avalanche Energy ^a | L = 0.1 mH | E _{AS} | 51 | mJ | |
| | T _C = 25 °C | Р | 50.7 ^b | W | |
| Maximum Power Dissipation ^a | T _A = 25 °C ^c | – P _D – | 2.1 | | |
| Operating Junction and Storage Temperature Ra | T _J , T _{stg} | - 55 to 150 | °C | | |

| THERMAL RESISTANCE RATINGS | | | | | |
|--|-------------------|-------|------|--|--|
| Parameter | Symbol | Limit | Unit | | |
| Junction-to-Ambient (PCB Mount) ^c | R _{thJA} | 60 | °C/W | | |
| Junction-to-Case (Drain) | R _{thJC} | 3 | | | |

Notes:

a. Duty cycle \leq 1 %.

b. See SOA curve for voltage derating.

c. When mounted on 1" square PCB (FR-4 material).



| SPECIFICATIONS (T ₁ = 25 °C, unless otherwise noted) | | | | | | |
|--|----------------------|---|-------|-------|-------|------|
| Parameter | Symbol | Test Conditions | Min. | Тур. | Max. | Unit |
| Static | • | · · · · | | | | |
| Drain-Source Breakdown Voltage | V _{DS} | $V_{DS} = 0 V, I_{D} = -250 \mu A$ | - 100 | | | V |
| Gate Threshold Voltage | V _{GS(th)} | $V_{DS} = V_{GS}$, $I_D = -250 \ \mu A$ | - 1 | | - 3.0 | |
| Gate-Body Leakage | I _{GSS} | $V_{DS} = 0 V, V_{GS} = \pm 20 V$ | | | ± 250 | nA |
| | I _{DSS} | $V_{DS} = -100 V, V_{GS} = 0 V$ | | | - 1 | μA |
| Zero Gate Voltage Drain Current | | V_{DS} = - 100 V, V_{GS} = 0 V, T_{J} = 125 °C | | | - 50 | |
| | | $V_{DS} = -80 \text{ V}, V_{GS} = 0 \text{ V}, T_{J} = 150 \text{ °C}$ | | | - 250 | |
| On-State Drain Current ^a | I _{D(on)} | $V_{DS} \le$ - 10 V, V_{GS} = - 10 V | - 30 | | | А |
| | _ | V _{GS} = - 10 V, I _D = - 14 A | | 0.22 | | Ω |
| Drain-Source On-State Resistance ^a | R _{DS(on)} | $V_{GS} = -4.5 \text{ V}, \text{ I}_{D} = -12 \text{ A}$ | | 0.24 | | |
| Forward Transconductance ^a | 9 _{fs} | V _{DS} = - 20 V, I _D = - 14 A | | 40 | | S |
| Dynamic ^b | • | • | | • | • | |
| Input Capacitance | C _{iss} | V _{GS} = 0 V, V _{DS} = - 20 V, f = 1 MHz | | 2765 | | pF |
| Output Capacitance | C _{oss} | | | 330 | | |
| Reverse Transfer Capacitance | C _{rss} | | | 280 | | |
| Total Gate Charge ^c | Qg | | | 67 | | nC |
| Gate-Source Charge ^c | Q _{gs} | $V_{DS} = -20 \text{ V}, V_{GS} = -10 \text{ V}, I_{D} = -14 \text{ A}$ | | 13.5 | | |
| Gate-Drain Charge ^c | Q _{gd} | | | 14 | | |
| Gate Resistance | Rg | f = 1 MHz | 0.5 | 2.5 | 5 | Ω |
| Turn-On Delay Time ^c | t _{d(on)} | | | 10 | 20 | |
| Rise Time ^c | t _r | $V_{DD} = -20 \text{ V}, \text{ R}_{L} = 2 \Omega$ $\text{I}_{D} \cong -10 \text{ A}, \text{ V}_{\text{GEN}} = -10 \text{ V}, \text{ R}_{g} = 1 \Omega$ | | 11 | 20 | ns |
| Turn-Off Delay Time ^c | t _{d(off)} | | | 42 | 63 | |
| Fall Time ^c | t _f | | | 12 | 20 | |
| Drain-Source Body Diode Ratings a | nd Characteri | istics T _C = 25 °C ^b | | | | |
| Continuous Current | ا _S | | | | - 36 | A |
| Pulsed Current | I _{SM} | | | | - 100 | |
| Forward Voltage ^a | V _{SD} | I _F = - 10 A, V _{GS} = 0 V | | - 0.8 | - 1.5 | V |
| Reverse Recovery Time | t _{rr} | I _F = - 10 A, dl/dt = 100 A/μs | | 38 | 57 | ns |
| Peak Reverse Recovery Current | I _{RM(REC)} | | | 2.3 | 3.5 | А |
| Reverse Recovery Charge | Q _{rr} | 1 | | 40 | 60 | nC |

Notes:

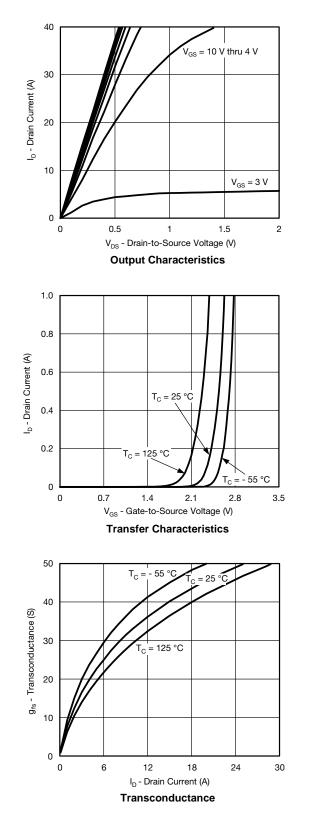
a. Pulse test; pulse width \leq 300 $\mu s,$ duty cycle \leq 2 %. b. Guaranteed by design, not subject to production testing.

c. Independent of operating temperature.

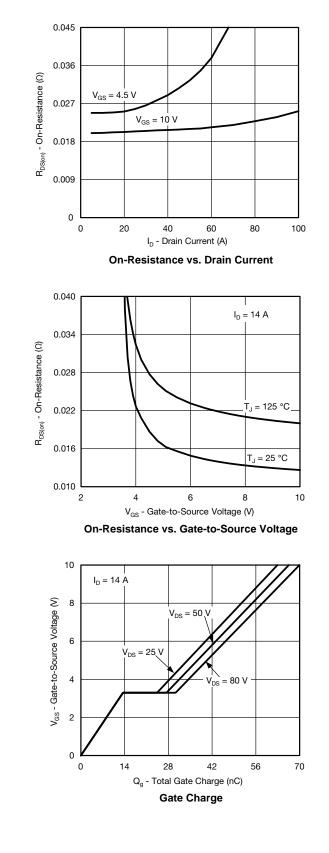
Stresses beyond those listed under "Absolute Maximum Ratings" may cause permanent damage to the device. These are stress ratings only, and functional operation of the device at these or any other conditions beyond those indicated in the operational sections of the specifications is not implied. Exposure to absolute maximum rating conditions for extended periods may affect device reliability.

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TYPICAL CHARACTERISTICS (25 °C, unless otherwise noted)





I_D = 250 μA

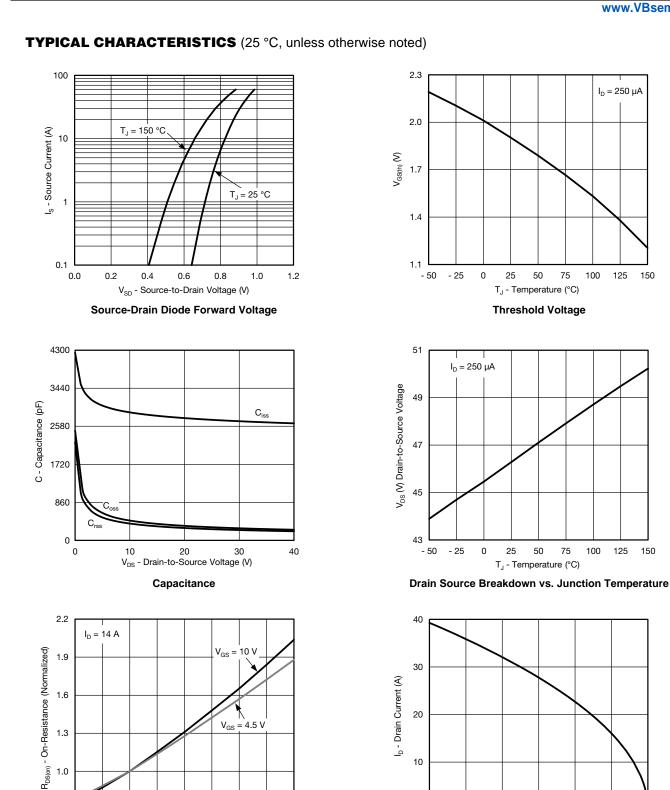
T_C - Case Temperature (°C)

Current Derating

T_J - Temperature (°C)

T_J - Temperature (°C)

Threshold Voltage

服务热线:400-655-8788



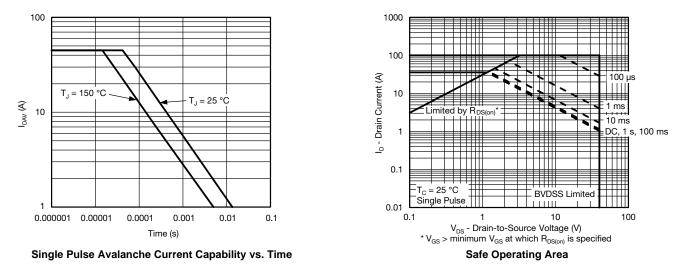
1.0

0.7

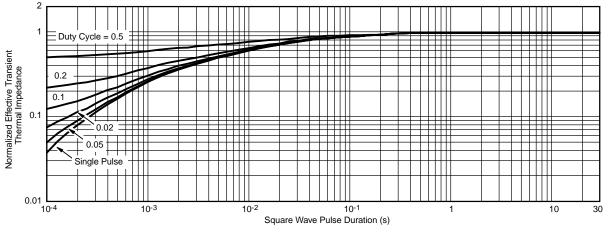
- 50 - 25 T_{.I} - Junction Temperature (°C)

On-Resistance vs. Junction Temperature





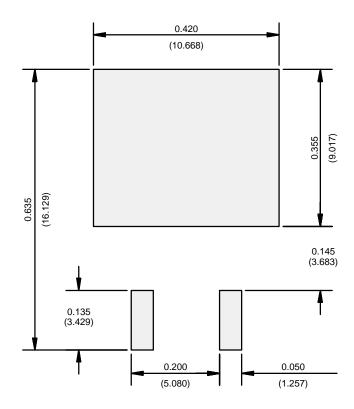
TYPICAL CHARACTERISTICS (25 °C, unless otherwise noted)



Normalized Thermal Transient Impedance, Junction-to-Case



RECOMMENDED MINIMUM PADS FOR D²PAK: 3-Lead



Recommended Minimum Pads Dimensions in Inches/(mm)



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